

Product specifications contained herein may be changed without prior notice. It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.

AND5BB

InGaN Ultra Bright Blue Light Emission Surface Mount Package

Features

RoHS Compliant

- Small package size (12mm tape on 7" diameter reel)
- · Compatible with automatic placement equipment
- Compatible with infrared & vapor phase reflow solder process
- Mono-color type

Maximum Ratings $(T_a = 25^{\circ}C)$

Characteristics	Symbol	Rating	Unit
Forward Current	I _F	30	mA
Reverse Voltage	V _R	5	V
Power Dissipation	P _D	120	mW
Operating Temperature Range	T _{Opr}	-20 to 80	°C
Storage Temperature Range	T _{Stg}	-30 to 90	°C

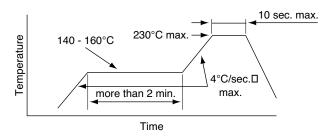
Electro-Optical Characteristics (T_a = 25°C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F = 20 mA	_	3.5	4.0	V
Reverse Current	I _R	V _R = 5 V	-	_	10	μΑ
Luminous Intensity	I _V	I _F = 20 mA	118	150	_	mcd
Peak Emission Wavelength	l _P	I _F = 20 mA	_	468	_	nm
Spectral Line Half Width	ΔΙ	I _F = 20 mA	_	40	_	nm
Dominant Wavelength	ld	I _F = 20 mA	_	470	_	nm
Full Viewing Angle	θ	I _V = 1/2 Peak	_	30	_	degree

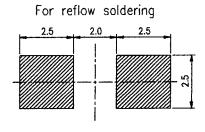
Precaution

Please be careful of the following:

- Manual soldering: maximum temperature of iron tip: 260°C max.
 Soldering time: within 5 sec. per solder-land
 Soldering portion of lead: up to 1.6 mm from the body of the device
- 2. Reflow solder: recommended condition is as follows:



 Absolute secure counter measures against static electricity and surge should be taken when handling these products. It is recommended to use wrist band or antistatic gloves when handling these LEDs.





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